



DMN3042LFDF

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
	28mΩ @ V <sub>GS</sub> = 10V	7.0A
30∨	32mΩ @ V <sub>GS</sub> = 4.5V	6.5A

# **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions

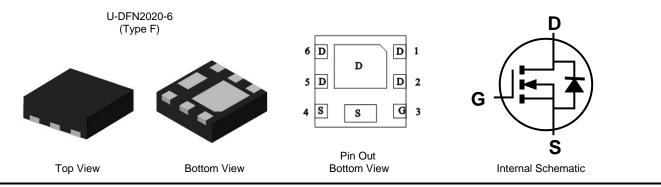
## **30V N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Features and Benefits**

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm<sup>2</sup>
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: U-DFN2020-6 (Type F)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 Per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.007 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3042LFDF-7	U-DFN2020-6 (Type F)	3,000/Tape & Reel
DMN3042LFDF-13	U-DFN2020-6 (Type F)	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.htmlfor more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



S7 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

#### Date Code Key

Notes:

Year	2016		2017	2018		2019	2020		2021	2022		2023
Code	D		E	F		G	Н			J		K
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	30	V	
Gate-Source Voltage		V <sub>GSS</sub>	±12	V	
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	7.0 5.6	A
Maximum Continuous Body Diode Forward Curren	t (Note 6)		Is	1.5	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	6)	I <sub>DM</sub>	35	A	
Avalanche Current (L = 0.1mH) (Note 7)		I <sub>AS</sub>	13	A	
Avalanche Energy (L = 0.1mH) (Note 7)			E <sub>AS</sub>	9	mJ

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.7	W	
Thermal Registeres, Junction to Ambient (Note 5)	Steady State	D	177	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ ext{ heta}}JA$	124	C/W	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.1	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	61	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ extsf{ heta}JA}$	43	C/VV	
Thermal Resistance, Junction to Case	Steady State	R <sub>θ</sub> JC	9.3	°C/W	
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)				•		·
Drain-Source Breakdown Voltage	<b>BV</b> <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						·
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.6	_	1.4	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
		_	17	28		$V_{GS} = 10V, I_D = 4.0A$
Static Drain-Source On-Resistance	Р	_	20	32	mΩ	$V_{GS} = 4.5V, I_D = 4.0A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	24	42	11122	$V_{GS} = 3.0V, I_D = 4.0A$
		_	28	50		$V_{GS} = 2.5V, I_D = 4.0A$
Diode Forward Voltage	V <sub>SD</sub>		0.7	1.2	V	$V_{GS} = 0V, I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						·
Input Capacitance	Ciss	_	570	—		
Output Capacitance	C <sub>oss</sub>	_	63	_	pF	$V_{DS} = 15V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	53	_		
Gate Resistance	Rq		3.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg		13.3	_		
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qq		6.1	_	-0	
Gate-Source Charge	Q <sub>gs</sub>		1.0		nC	$V_{DS} = 15V, I_D = 6.9A$
Gate-Drain Charge	Q <sub>gd</sub>		1.6	—		
Turn-On Delay Time	t <sub>D(ON)</sub>		1.5			
Turn-On Rise Time	t <sub>R</sub>	_	3.3	_		$V_{GS} = 10V, V_{DD} = 15V, R_G = 3\Omega,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	13.9	_	ns	$I_{\rm D} = 6.9 {\rm A}$
Turn-Off Fall Time	t <sub>F</sub>		4.9	_		
Body Diode Reverse Recovery Time	t <sub>RR</sub>		7.8	_	ns	I <sub>S</sub> = 5A, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		1.9	_	nC	$I_{S} = 5A, dI/dt = 100A/\mu s$

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

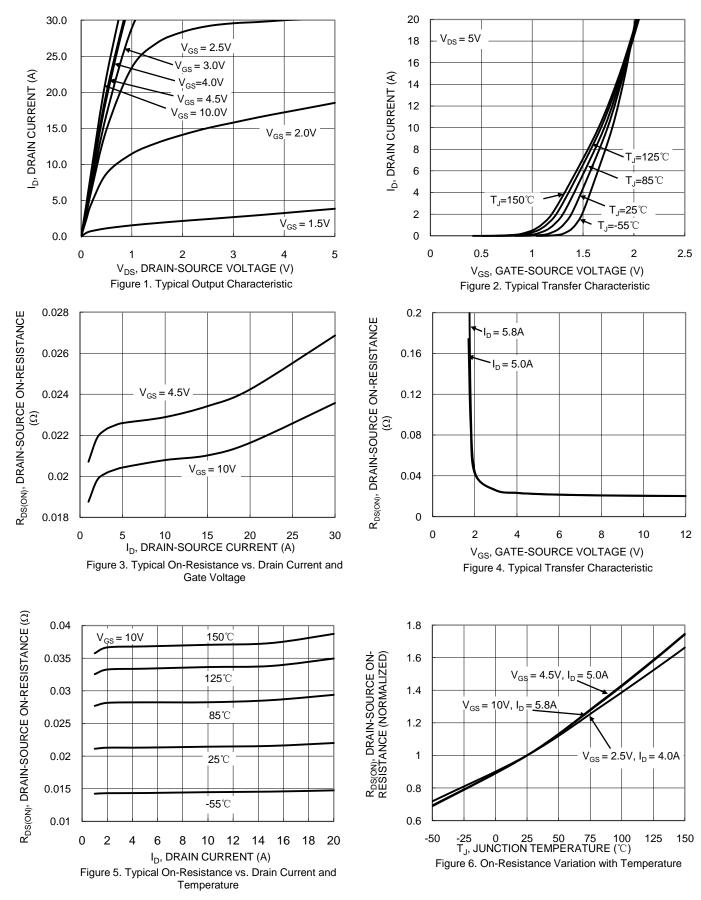
7.  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

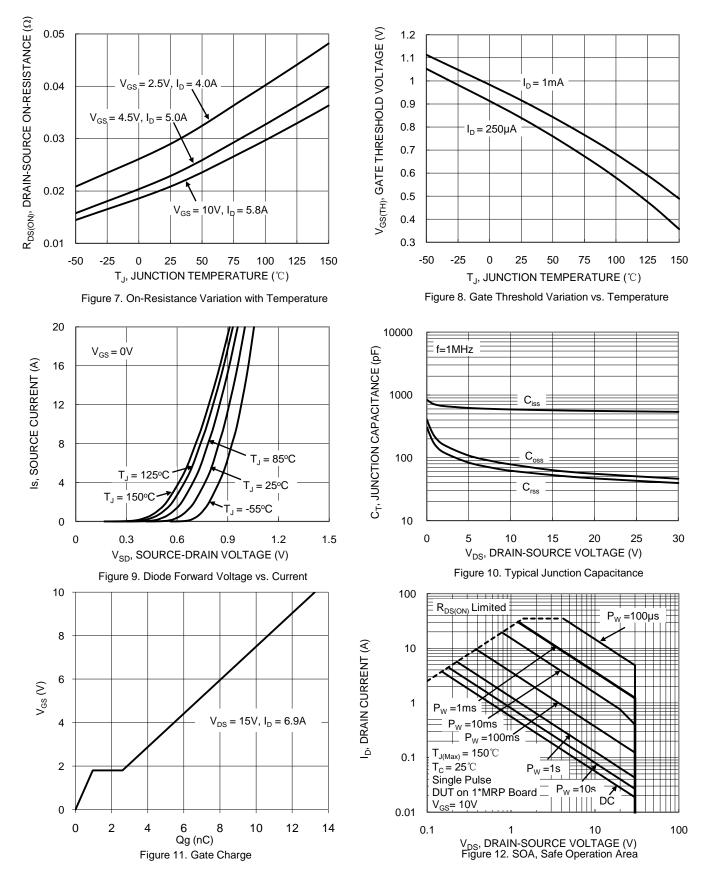


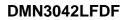
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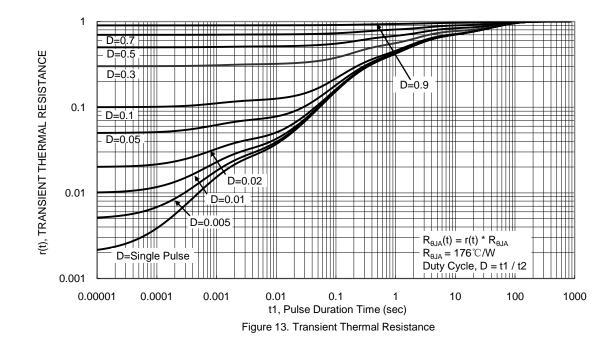


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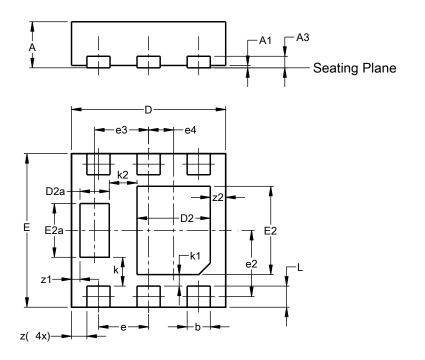






# Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

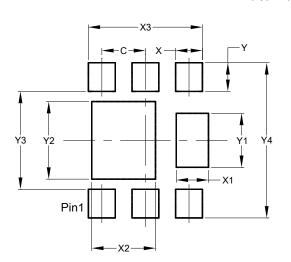


U-DFN2020-6 (	Type F)
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	U-DFN2020-6 (Type F)							
Dim	Min	Max	Тур					
Α	0.57	0.63	0.60					
A1	0.00	0.05	0.03					
A3	-	-	0.15					
b	0.25	0.35	0.30					
D	1.95	2.05	2.00					
D2	0.85	1.05	0.95					
D2a	0.33	0.43	0.38					
Е	1.95	2.05	2.00					
E2	1.05	1.25	1.15					
E2a	0.65	0.75	0.70					
е	0.65 BSC							
e2	(	).863 BS	SC					
e3		0.70 BS	С					
e4	(	).325 BS	SC					
k		0.37 BS						
k1		0.15 BS	С					
k2		0.36 BS	-					
L	0.225	0.325	0.275					
z		0.20 BS	С					
z1	0	).110 BS	SC					
z2		0.20 BS	С					
All D	imens	ions in	mm					

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



### U-DFN2020-6 (Type F)

Dimensions	Value (in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
X3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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